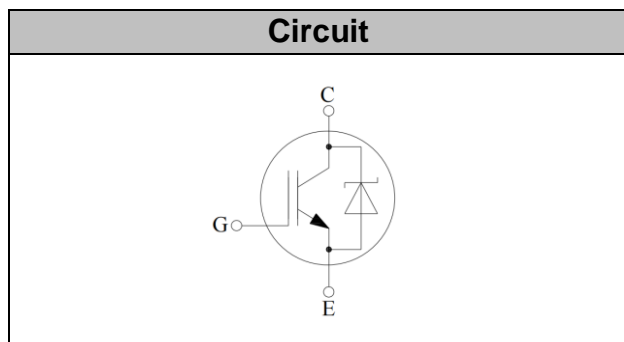


IGBT Discrete

V_{CE}	650	V
I_C	75	A
$V_{CE(SAT)} I_C=75A$	1.45	V



Applications

- Resonant converters
- Uninterruptible power supplies
- Welding converters
- Mid to high range switching frequency converters

Features

- High speed smooth switching device for hard & soft switching
- Maximum junction temperature 175°C
- Positive temperature coefficient
- High ruggedness, temperature stable
- Including SiC FWD

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC Collector Current, limited by T_{jmax} $T_C=25^\circ C$ value limited by bondwire $T_C=100^\circ C$	I_C	85 80	A
Diode Forward Current, limited by T_{jmax} $T_C=25^\circ C$ value limited by bondwire $T_C=100^\circ C$	I_F	85 75	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage ($t_p \leq 10\mu s, D < 0.010$)	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \leq 650V$, $T_j \leq 150^\circ C$		300	A
Pulsed Collector Current, $V_{GE}=15V$, t_p limited by T_{jmax}	I_{CM}	300	A
Diode Pulsed Current, t_p limited by T_{jmax}	I_{Fpuls}	300	A
Power Dissipation, $T_j=175^\circ C, T_c=25^\circ C$	P_{tot}	428	W



Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	650		-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=0.75mA$	3.2	4.0	4.8	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=75A$ $T_j=25^\circ\text{C}$, $T_j=125^\circ\text{C}$ $T_j=150^\circ\text{C}$	1.10	1.45 1.60 1.70	1.75	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=650V, V_{GE}=0V$ $T_j=25^\circ\text{C}$, $T_j=150^\circ\text{C}$			0.25 3.00	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$			100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1MHz$	-	4.75	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.04	-	
Gate Charge	Q_G	$V_{CC}=520V, I_C=75A,$ $V_{GE}=15V$	-	0.18	-	uC



Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =75A, V _{GE} = -5v~15V, R _g =10Ω, Inductive Load	-	32	-	ns
Rise Time	t _r		-	83	-	ns
Turn-on Energy	E _{on}		-	2.18	-	mJ
Turn-off Delay Time	t _{d(off)}		-	121	-	ns
Fall Time	t _f		-	49	-	ns
Turn-off Energy	E _{off}		-	1.11	-	mJ
Total switching energy	E _{ts}		-	3.29	-	mJ
Dynamic , at T_j= 125°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =75A, V _{GE} = -5v~15V, R _g =10Ω, Inductive Load	-	30	-	ns
Rise Time	t _r		-	86	-	ns
Turn-on Energy	E _{on}		-	2.25	-	mJ
Turn-off Delay Time	t _{d(off)}		-	135	-	ns
Fall Time	t _f		-	68	-	ns
Turn-off Energy	E _{off}		-	1.43	-	mJ
Total switching energy	E _{ts}		-	3.68	-	mJ
Dynamic , at T_j= 150°C						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =75A, V _{GE} = -5v~15V, R _g =10Ω, Inductive Load	-	29	-	ns
Rise Time	t _r		-	88	-	ns
Turn-on Energy	E _{on}		-	2.28	-	mJ
Turn-off Delay Time	t _{d(off)}		-	142	-	ns
Fall Time	t _f		-	76	-	ns
Turn-off Energy	E _{off}		-	1.57	-	mJ
Total switching energy	E _{ts}		-	3.85	-	mJ

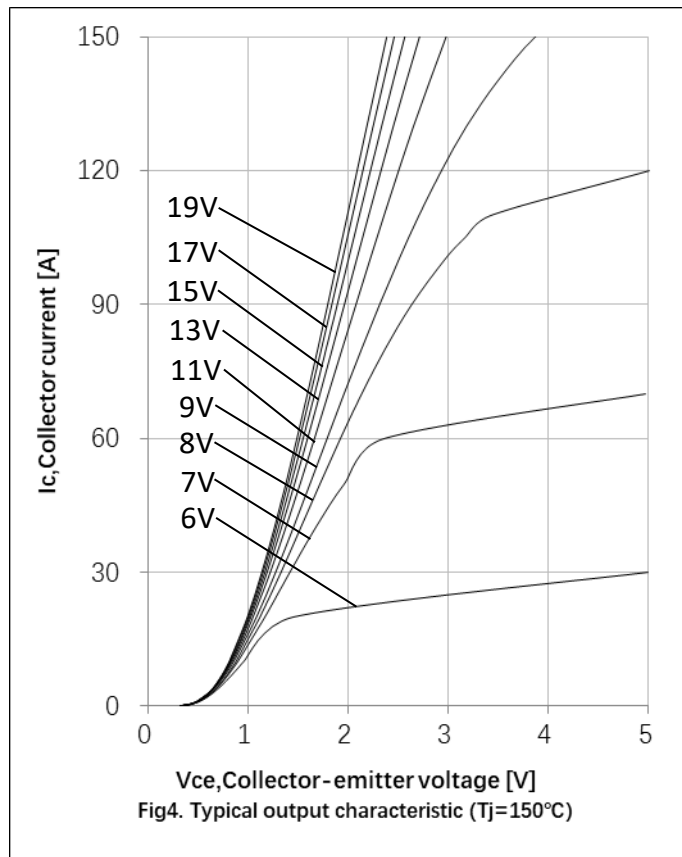
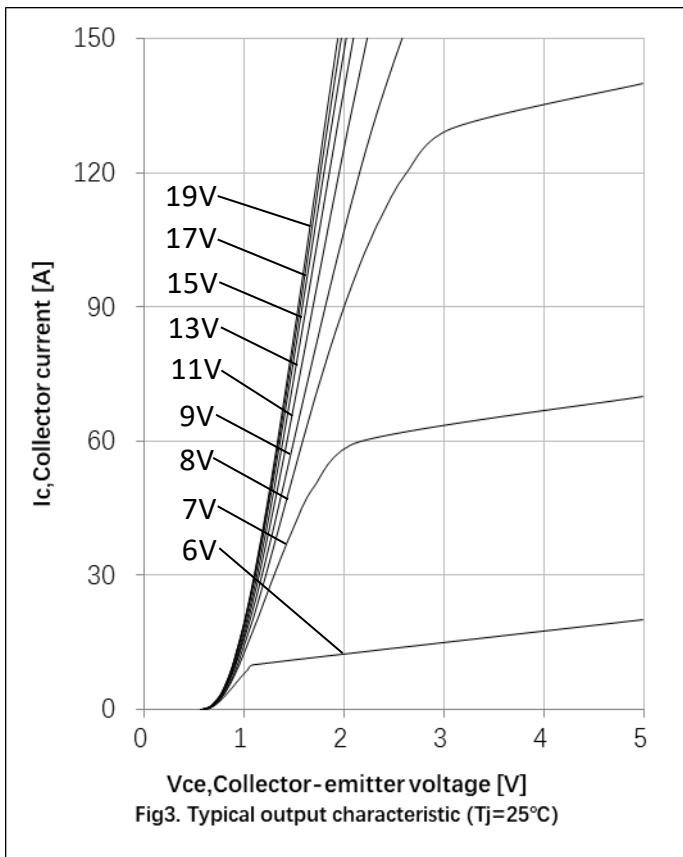
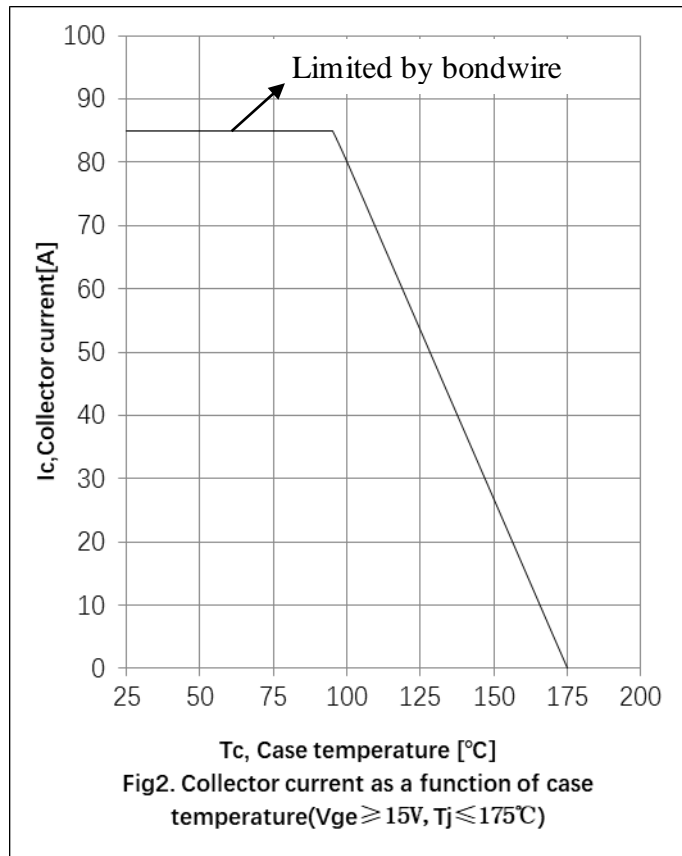
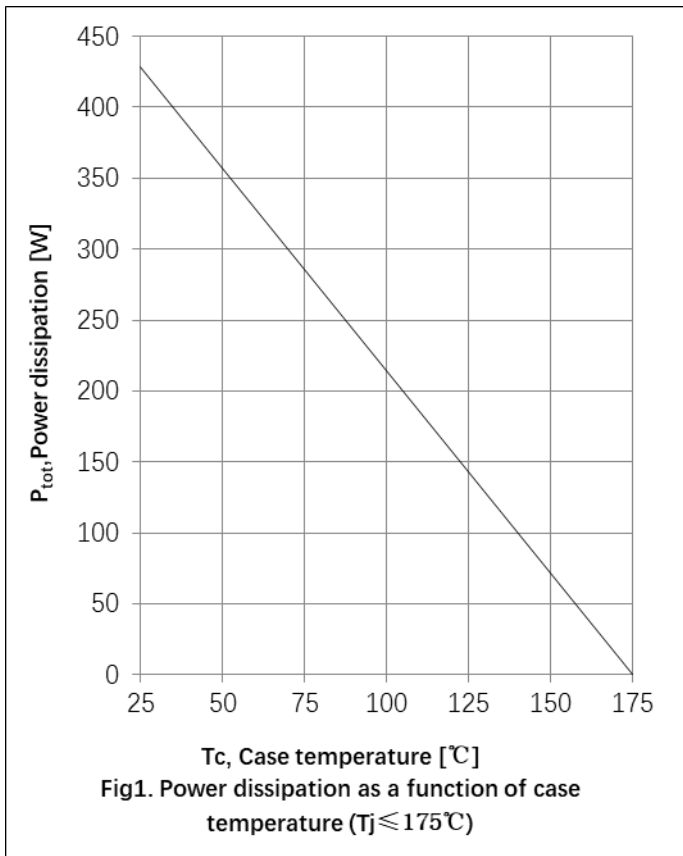


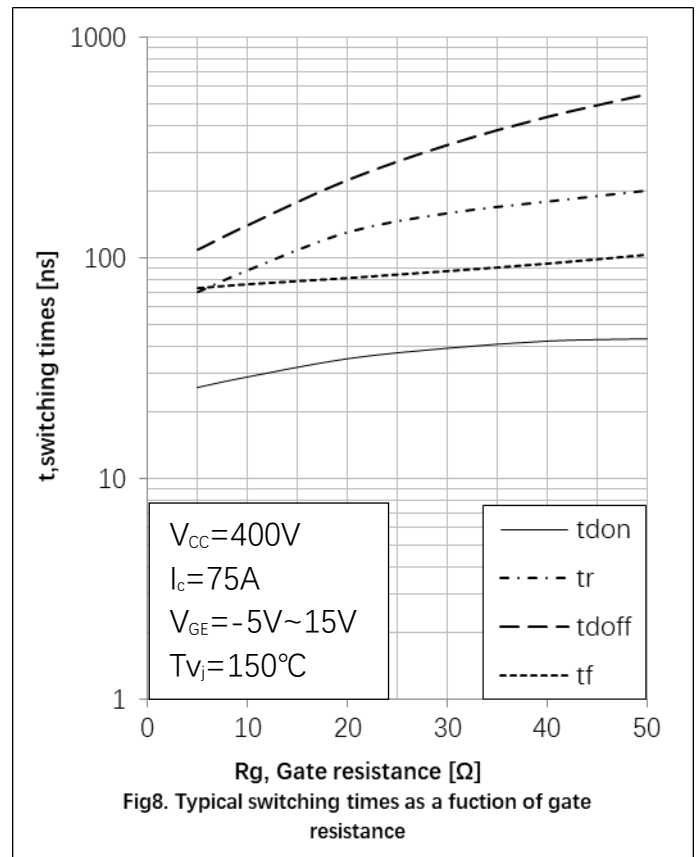
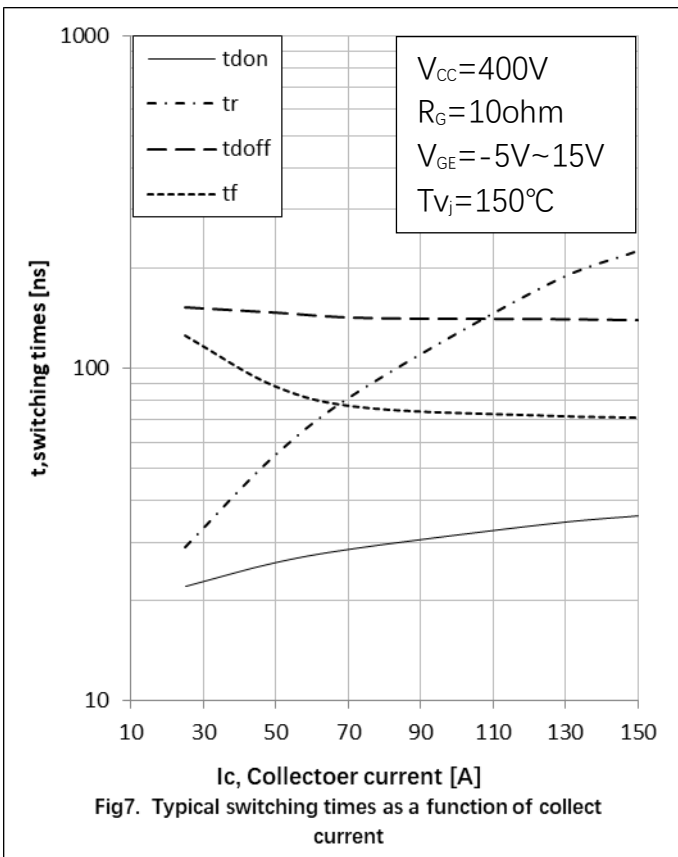
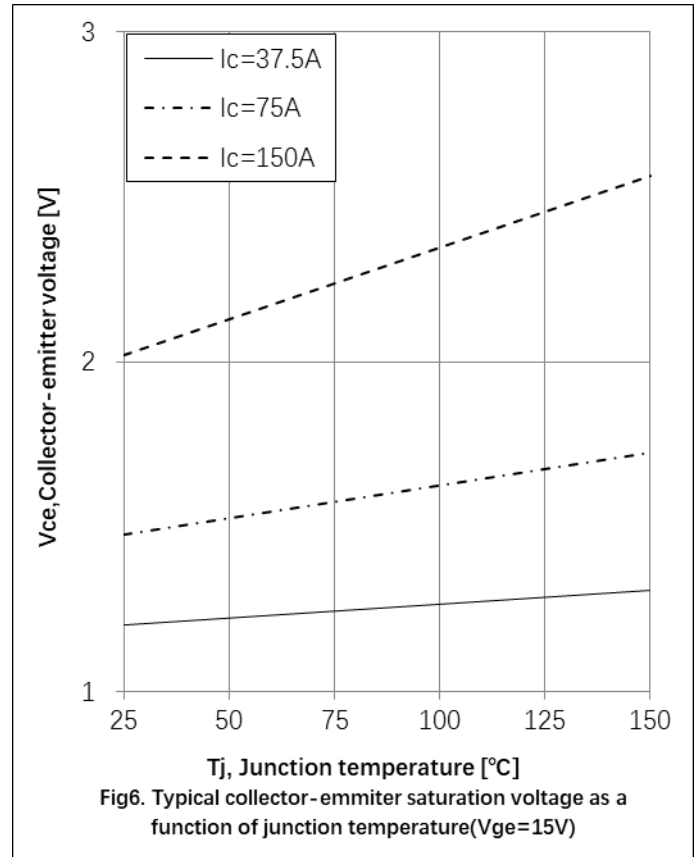
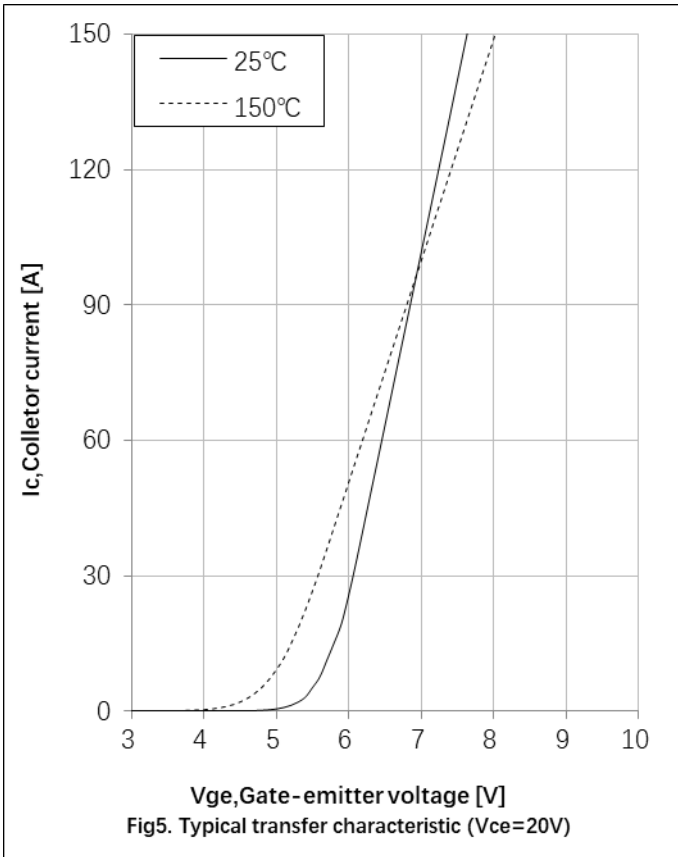
Electrical Characteristics of the DIODE

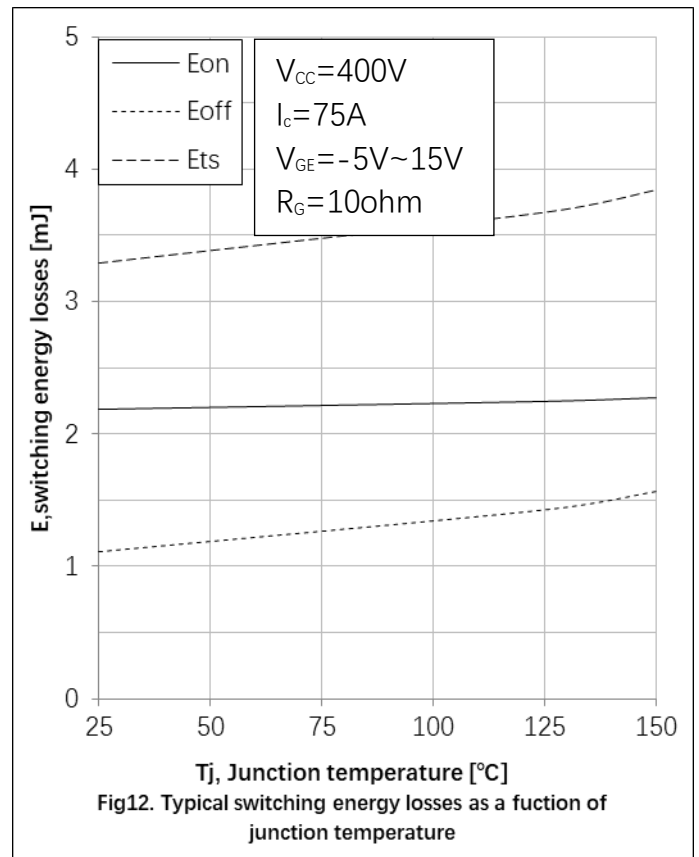
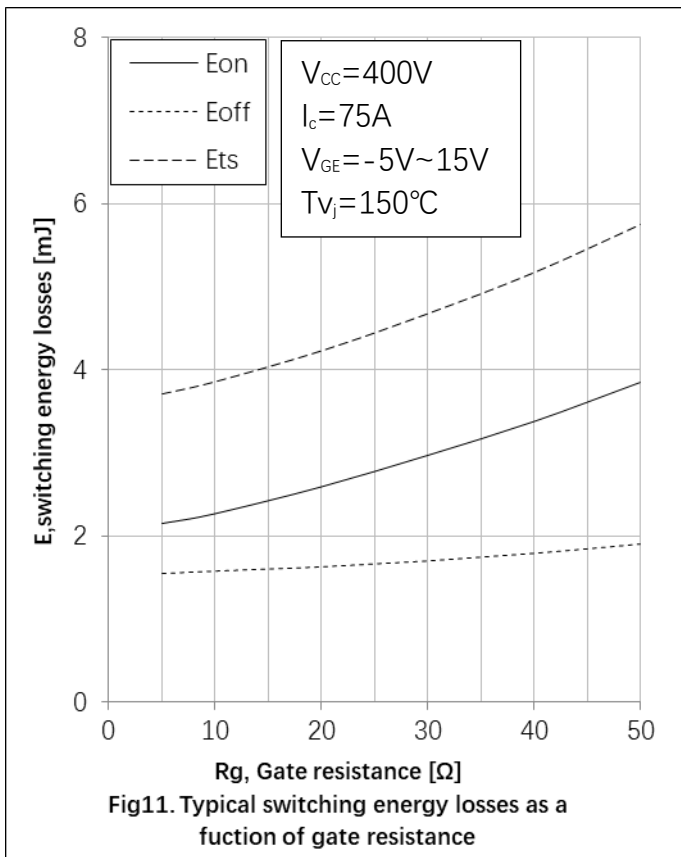
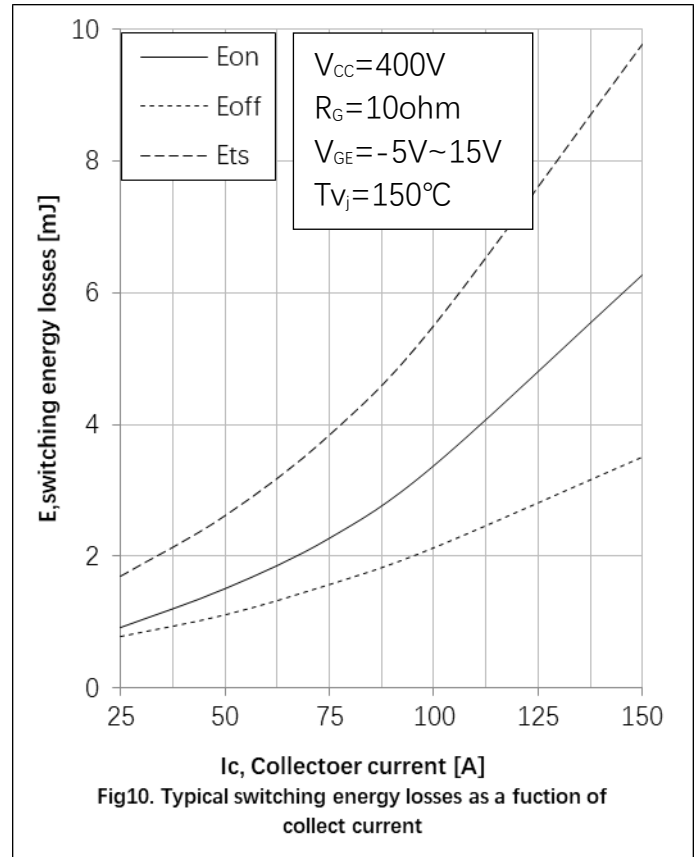
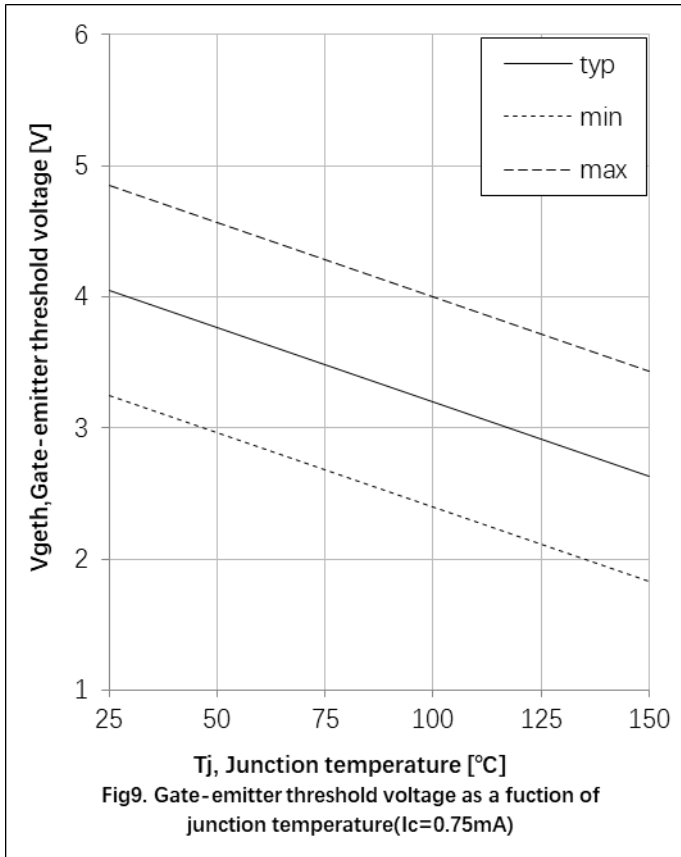
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Diode Forward Voltage	V_F	$I_F=75A$ $T_J=25^{\circ}C$, $T_J=175^{\circ}C$		1.70 2.60	1.90	V
Diode Capacitive Charge	Q_C	$V_R=400V$, $T_J=25^{\circ}C$		135		nC
Diode Capacitance	C	$f=1MHz$ $V_R=0V$, $V_R=200V$ $V_R=400V$		2453 247 243		pF

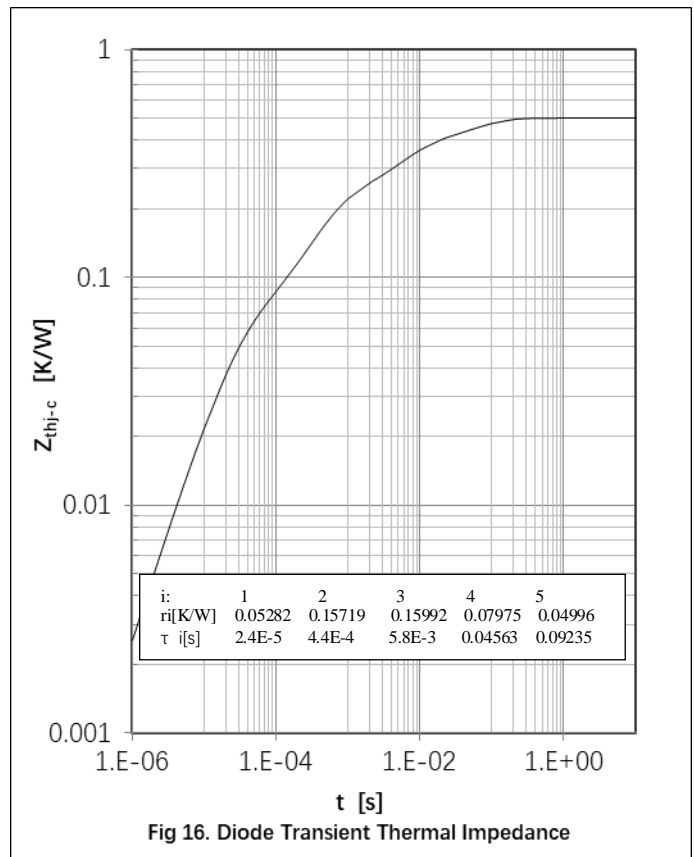
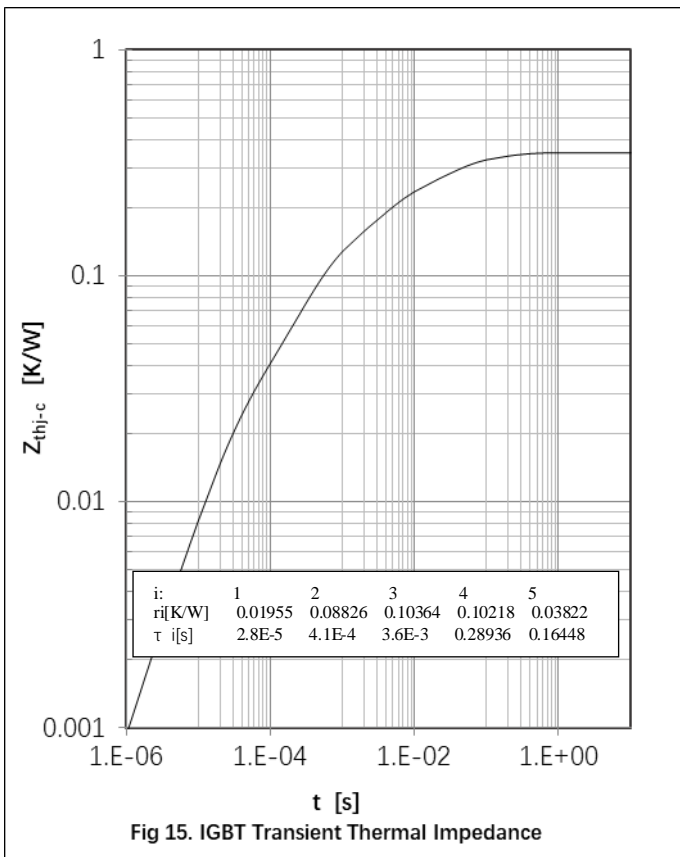
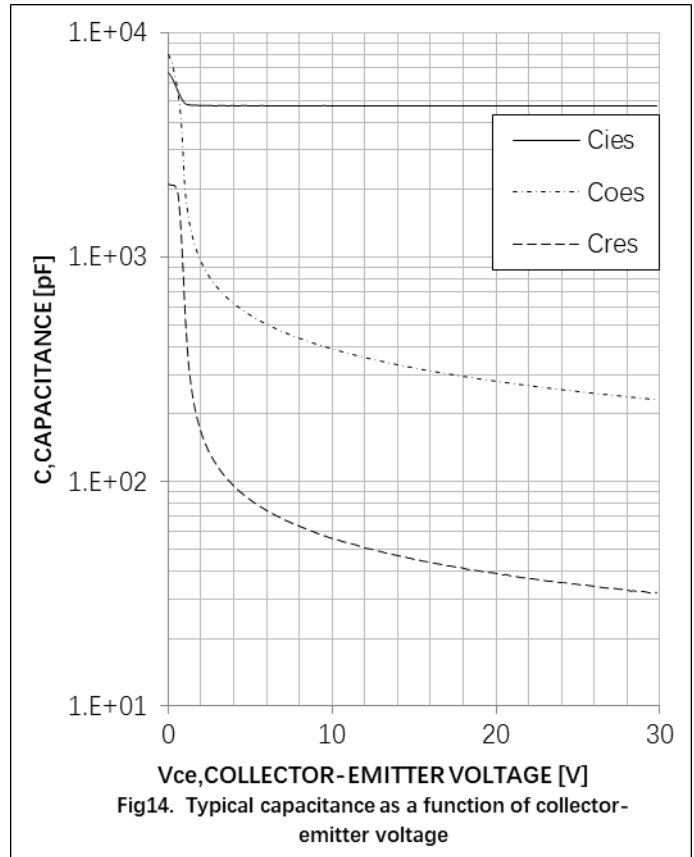
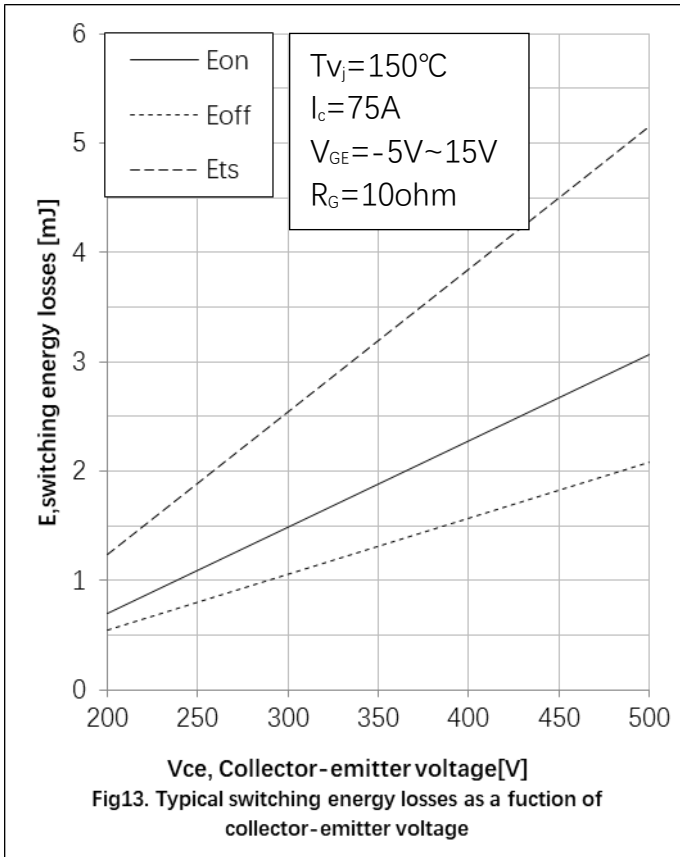
Thermal Resistance

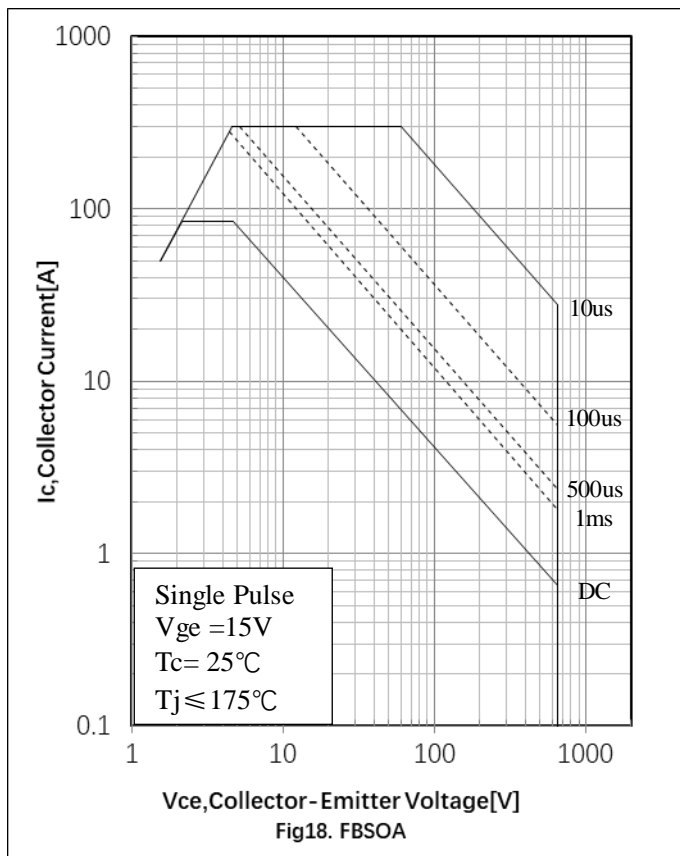
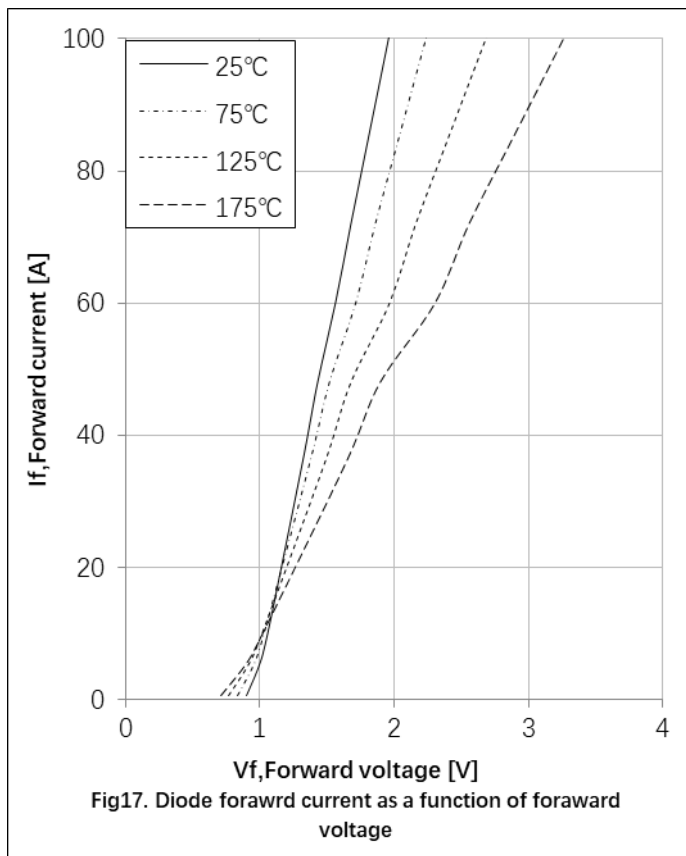
Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	$R_{th(j-c)}$	0.35	K/W
Diode Thermal Resistance, Junction - Case	$R_{th(j-c)}$	0.50	K/W
Thermal Resistance, Junction - Ambient	$R_{th(j-a)}$	40	K/W



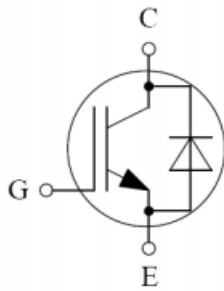




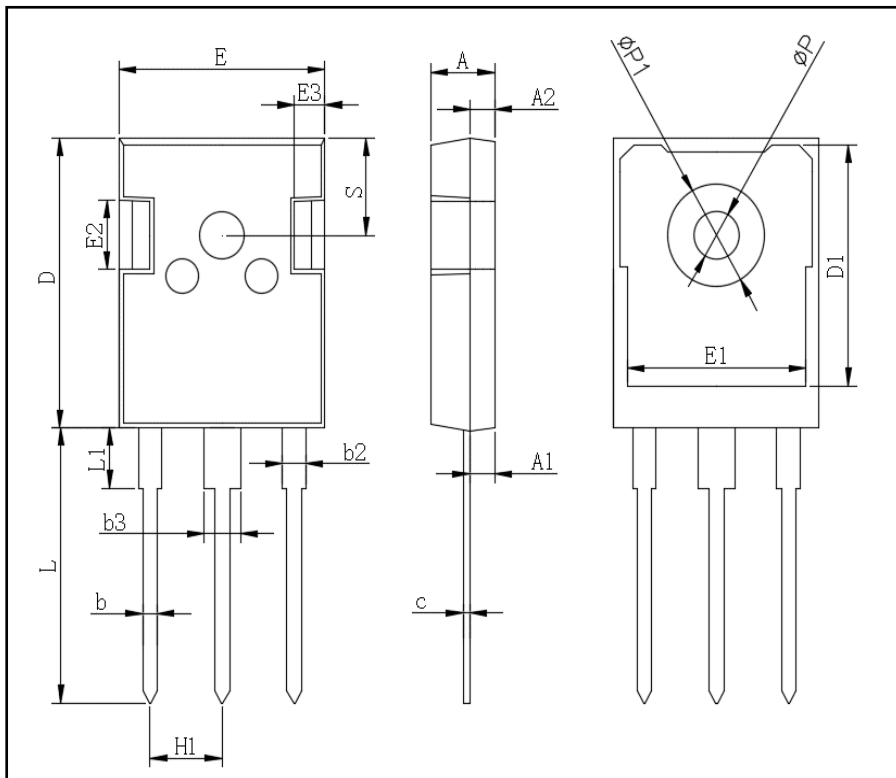




● **Circuit Diagram**



● **Package Outline Information**



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
Φ P	3.40	3.80
Φ P1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale. This publication supersedes & replaces all information previously supplied. For additional information, please visit our website [http:// www.21yangjie.com](http://www.21yangjie.com) , or consult your nearest Yangjie's sales office for further assistance.